ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES*						This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.												
	IPC Web Site for Information on IPC-1752 Standard Form Tyj http://www.ipc.org/IPC-175x Distribute				Form Type Distribute	e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					rials and M	ials and Mfg Information						
Supplier Information	n																	
Company name*			Company unique ID				Unique ID Authority						Respon	Response Date*				
onsemi													2025-07	2025-07-13				
Contact Name			Title - Contact				Phone - Contact*						Email -	Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance				NA					Produc	Product-Env-Stewards@onsemi.com					
Authorized Representative*			Title - Representative			Phone - Representative*					Email -	Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance				NA					Produc	Product-Env-Stewards@onsemi.com					
Requester Item	Requester Item Number Mfr Iten		n Number Mfr Item Name				Effective Date Version		Version	N	Manufacturing Site			Weig	ht*	UOM	Unit Type	
	CM1214A-02MR		A-02MR	2 CH ESD			2025-07-	13						24.6		mg	Each	
Manufacturing Proc	ccess Information			ı														
Terminal Platin	Terminal Plating / Grid Array Material		erminal Base A	al Base Alloy J-STD-020		L Rating	Peak Proc		ess Body Temperature		are Max Time at Peak Temper		k Tempera	ture	e Number of Reflow Cycles			
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260			С		30 seco		nds	3			
Comments																		
evel 1 - maximum time a	t peak temperature d	uring sol	dering is 10-3	0 seconds														
For more information reg	garding material com	position _j	please refer to	page 3														

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead b), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl nthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.												
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Clip	11.37	mg	Supplier	Zinc (Zn)	7440-66-6		0.0136	mg	
			Supplier	Iron (Fe)	7439-89-6		0.2729	mg	
			Supplier	Copper (Cu)	7440-50-8		11.0744	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.0091	mg	
Die	1.39	mg	Supplier	Silicon (Si)	7440-21-3		1.39	mg	
Die Attach	0.19	mg	Supplier	Silver (Ag)	7440-22-4		0.1425	mg	
			Supplier	Epoxy resins	129915-35-1		0.0475	mg	
Mold Compound-Black	11.09	mg		Epoxy Phenol Resin	proprietary data		1.1644	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		9.9255	mg	
Plating	0.08	mg	Supplier	Palladium (Pd)	7440-05-3		0.0214	mg	
			В	Nickel (Ni)	7440-02-0		0.0556	mg	
			Supplier	Gold (Au)	7440-57-5		0.003	mg	
Wire Bond - Au	0.48	mg	Supplier	Gold (Au)	7440-57-5		0.48	mg	